

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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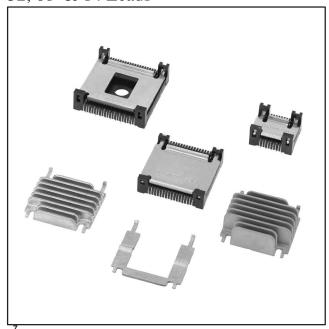
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







32, 68 & 84 Leads



- Accepts JEDEC leadless ceramic chip carriers
- Variety of lid options available only for 68 position
- "U" lid for I.C.E. adaptor I/O cable exit
- Heat Sink available for 68 position
- Polarizing post on bottom of socket
- No tools required for package insertion/removal
- Full contact probe-ability
- High temperature PPS plastic and BeCu contacts for rugged performance

Date Issued: February 22, 2001

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Physical

Insulation

Material: Glass Filled Polyphenylene Sulfide (PPS)

Flammability: UL 94V-0 Color: Black

Contact

Material: Beryllium Copper

Plating: 50 µ" [1.27 µm] Nickel with Gold Flash in wiping area and solder tails

Lid Material: Aluminum

Marking: Raised Letters: 3M Logo & Part Identification

Electrical

Current Rating: 1 A

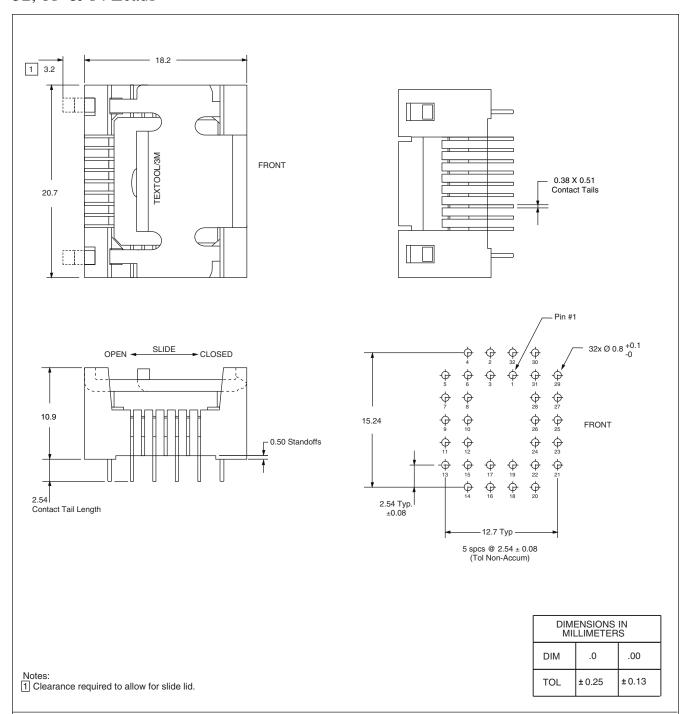
Insulation Resistance: $> 1 \times 10^{12} \Omega$ at 500 Vdc **Withstanding Voltage:** 1000 Vrms at Sea Level

Environmental

Temperature Rating Operating: - 55 TC to +105 TC

UL File No.: E68080

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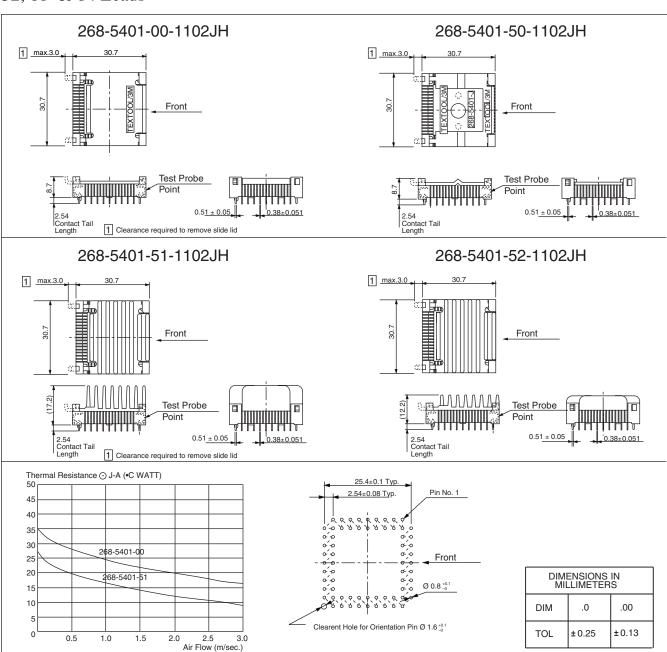
Ordering Information

Lead Count	Part Number	Description	Device Thickness		
			Length	Width	Thickness*
32	232-1271-00-1102ЈН	Solid Lid			

*Device Thickness does not include cover.

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32, 68 & 84 Leads

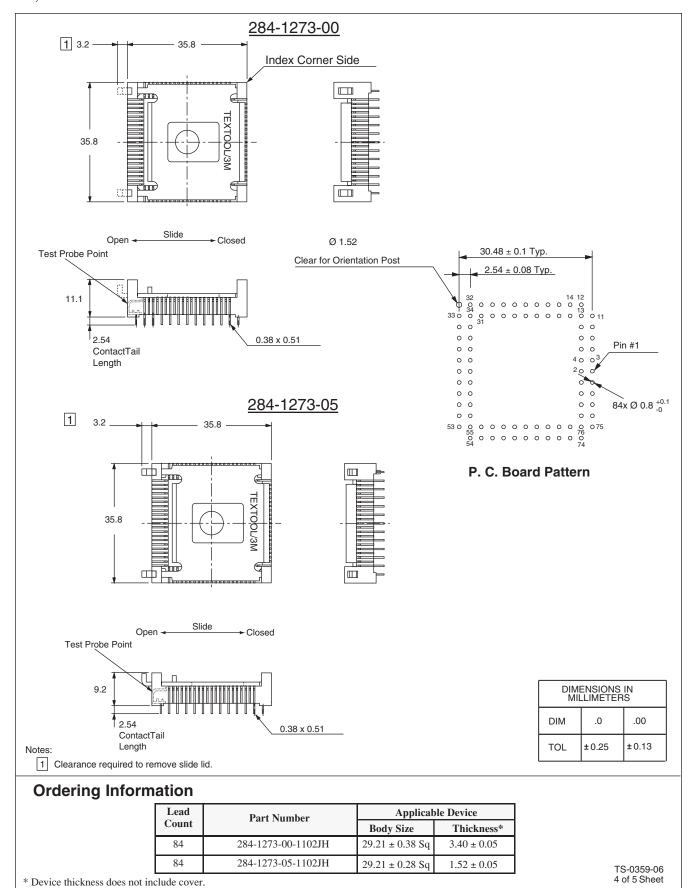


Ordering Information

Lead Count	Part Number	Description	Applicable Device	
	Tart Number	Description	Body Size	Thickness
68	268-5401-00-1102ЈН	Chip Carrier-LCC with Full Lid	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-00-0000	Lid - Full	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-11-1102ЈН	End Use-LCC Type "A" Base Sub-assembly	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-50-0000	Lid-U Shape	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-50-1102ЈН	Chip Carrier-LCC with U-Shape Lid	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-51-0000	Lid –11 mm Heat Sink	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-51-1102ЈН	Chip Carrier-LCC with 11 mm Heat Sink	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-52-0000	Lid – 6 mm Heat Sink	24.13 ± 0.25	1.52 ± 0.15
68	268-5401-52-1102ЈН	Chip Carrier-LCC with 6 mm Heat Sink	24.13 ± 0.25	1.52 ± 0.15

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32, 68 & 84 Leads



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